

Type	Hits	Search Text	Dbs	Time Stamp	Comments	Error Definiti on
1 BRS	3652	700/51,80,83,89,100,109-110,121,169,291,19-21,50,108,9.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:00		
2 BRS	4830	438/5,10,14,17.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:18		
3 BRS	1231	716/2,4.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:18		
4 BRS	6386	702/136,22-24,27,28,30-32,33-36,40,56,57,64,65,81-84,99,104,113-119,124,126,130,133,132,134,138,183,184,189.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:17		
5 BRS	7089	702/136,22,23,24,27,28,30,31,32,33,34,35,36,40,56,57,64,65,81,82,83,84,99,104,113,114,115,116,117,118,119,124,126,130,133,132,134,138,183,184,189.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:17		
6 BRS	4047	700/51,80,83,89,100,109,110,121,169,291,19,20,21,50,108,9.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:18		

Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
7 BRS	5105	438/5,10,14,17.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:18		
8 BRS	1569	716/2,4.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:18		
9 BRS	2	consumption\$1 with semiconductor with fabricat\$3 with process\$3 and tool\$1 with control\$4 with software\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:49		
10 BRS	3	consumption\$1 with semiconductor with fabricat\$3 with process\$3 and tool\$1 with control\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:02		
11 BRS	84	consumption\$1 with semiconductor with fabricat\$3 with process\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:19		
12 BRS	7	(utilit\$3 or consumption or resource\$1) with semiconductor with fabricat\$3 with process\$3 and tool\$1 with control\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:24		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
13	BRS	151	(utilit\$3 or consumption or resource\$1) with semiconductor with fabricat\$3 with process\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 09:24		
14	BRS	22	(utilit\$3 or consumption or resource\$1) with semiconductor with fabricat\$3 with process\$3 and tool\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:25		
15	BRS	3	(utilit\$3 or consumption or resource\$1) with semiconductor with fabricat\$3 with process\$3 and tool\$1 with (software or program\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 09:07		
16	BRS	78	monitor\$3 with (consumpt\$3 or utilit\$3) with semiconductor\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:23		
17	BRS	11	monitor\$3 with (consumpt\$3 or utilit\$3) with semiconductor\$1 and (controller\$1 or processor\$1) with (program\$4 or software)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 09:31		
18	BRS	3	monitor\$3 with (consumpt\$3 or utilit\$3) with semiconductor\$1 and (controller\$1 or processor\$1) with memory	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 09:07		

Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
19 BRS	181	semiconductor\$1 and tool\$1 with (controller\$1 or processor\$1) with memory	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:09		
20 BRS	14	monitor\$3 with (consumpt\$3 or utilit\$3 or resource\$1) with semiconductor\$1 and (controller\$1 or processor\$1) with (program\$4 or software)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 09:29		
21 BRS	57	semiconductor\$1 and (consumpt\$3 or utilit\$3 or resource\$1) and tool\$1 with (controller\$1 or processor\$1) with memory	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 06:51		
22 BRS	9	(process\$3 adj tool\$1) with controller\$1 with memory	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 09:09		
23 BRS	8481	702/136,22-24,27,28,30-32,33-36,40,56,57,64,65,81-84,99,104,113-119,124,126,130,133,132,134,138,183,184,189.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:17		
24 BRS	8481	702/136,22,23,24,27,28,30,31,32,33,34,35,36,40,56,57,64,65,81,82,83,84,99,104,113,114,115,116,117,118,119,124,126,130,133,132,134,138,183,184,189.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:17		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
25	BRS	4770	700/51,80,83,89,100,109,110,121,169,291,19,20,21,50,108,9.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:18		
26	BRS	5540	438/5,10,14,17.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:18		
27	BRS	2143	716/2,4.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/31 17:18		
28	BRS	3	consumption\$1 with semiconductor with fabricat\$3 with process\$3 and tool\$1 with control\$4 with software\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 06:51		
29	BRS	94	semiconductor\$1 and (consumpt\$3 or utilit\$3 or resource\$1) and tool\$1 with (controller\$1 or processor\$1) with memory	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 06:51		
30	BRS	4	consumption\$1 with semiconductor with fabricat\$3 with process\$3 and tool\$1 with control\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:02		

	Type	Hits	Search Text	Dbs	Time Stamp	Comments	Error Definiti on
31	BRS	258	semiconductor\$1 and tool\$1 with (controller\$1 or processor\$1) with memory	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:09		
32	BRS	103	monitor\$3 with (consumpt\$3 or utilit\$3) with semiconductor\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:23		
33	BRS	8	(utilit\$3 or consumption or resource\$1) with semiconductor with fabricat\$3 with process\$3 and tool\$1 with control\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:24		
34	BRS	30	(utilit\$3 or consumption or resource\$1) with semiconductor with fabricat\$3 with process\$3 and tool\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 07:25		
35	BRS	4770	700/51,80,83,89,100,109-11 0,121,169,291,19-21,50,108 ,9.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:00		
36	BRS	5540	438/5,10,14,17.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:18		

	Type	Hits	Search Text	Dbs	Time Stamp	Comments	Error Definiti on
37	BRS	2143	716/2,4.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:18		
38	BRS	112	consumption\$1 with semiconductor with fabricat\$3 with process\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 11:54		
39	BRS	2	"20020120425"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:31		
40	IS&R	1	("6782343").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:32		
41	BRS	0	resource with consumption\$1 with semiconductor with fabricat\$3 with process\$3 with controller	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:48		
42	BRS	1	resource with consumption\$1 with semiconductor with fabricat\$3 with process\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:49		

Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definitio
43 BRS	1	resource with consumption\$1 with semiconductor with fabricat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:49		
44 BRS	3	consumption\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with fabricat\$3 with process\$3 and tool\$1 with control\$4 with software\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:54		
45 BRS	1	(sum\$3 or cumulat\$3) with consumption\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with fabricat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:55		
46 BRS	284	consumption\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with fabricat\$3 with process\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 11:55		
47 BRS	107	(sum\$3 or cumulat\$3) with consumption\$1 and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with fabricat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:55		



	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
48	BRS	49	(sum\$3 or cumulat\$3) with consumption\$1 and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with fabricat\$3 and controller\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:56		
49	BRS	46	(sum\$3 or cumulat\$3) with consumption\$1 and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with fabricat\$3 and controller\$1 and process\$3 with control\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:58		
50	BRS	2	(sum\$3 or cumulat\$3) with consumption\$1 and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with fabricat\$3 and controller\$1 and process\$3 with control\$4 and sample\$1 with parameter\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:59		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
			(sum\$3 or cumulat\$3) with consumption\$1 and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with fabricat\$3 and controller\$1 and process\$3 with control\$4 and value\$1 with parameter\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:59		
51	BRS	9		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 08:59		
52	BRS	2	"20020055801"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 09:02		
53	IS&R	2	("5586059").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 09:08		
54	BRS	198	(utilit\$3 or consumption or resource\$1) with semiconductor with fabricat\$3 with process\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 09:24		
55	BRS	18	monitor\$3 with (consumpt\$3 or utilit\$3) with semiconductor\$1 and (controller\$1 or processor\$1) with (program\$4 or software)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/01 09:31		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
56	BRS	3	consumption\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with fabricat\$3 and calibrat\$3 with factor\$1	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:12 IBM_TDB			
57	BRS	4	(utilit\$3 or consumption or resource\$1) with semiconductor with fabricat\$3 with process\$3 and tool\$1 with (software or program\$4)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:07 IBM_TDB			
58	BRS	7	monitor\$3 with (consumpt\$3 or utilit\$3) with semiconductor\$1 and (controller\$1 or processor\$1) with memory	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:08 IBM_TDB			
59	BRS	14	(process\$3 adj tool\$1) with controller\$1 with memory	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:09 IBM_TDB			
60	BRS	3	consumption\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with calibrat\$3 with factor\$1	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 14:14 IBM_TDB			

Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
61 BRS	22	monitor\$3 with (consumpt\$3 or utilit\$3 or resource\$1) with semiconductor\$1 and (controller\$1 or processor\$1) with (program\$4 or software)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:29 IBM_TDB			
62 BRS	0	total with consumption\$1 with resource\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with (sum\$4 or cumulat\$3 or accumul\$3 or add\$5) with (time or period\$1 or interval\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:36 IBM_TDB			
63 BRS	0	consumption\$1 with resource\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with (sum\$4 or cumulat\$3 or accumul\$3 or add\$5) with (time or period\$1 or interval\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:36 IBM_TDB			
64 BRS	3	total with consumption\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with (sum\$4 or cumulat\$3 or accumul\$3 or add\$5) with (time or period\$1 or interval\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:38 IBM_TDB			

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
65	BRS	220	consumption\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with (sum\$4 or cumulat\$3 or accumul\$3 or add\$5) with (time or period\$1 or interval\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:37 IBM_TDB			
66	BRS	58	total with consumption\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with (time or period\$1 or interval\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:47 IBM_TDB			
67	BRS	2	total adj consumption\$1 adj (time or period\$1 or interval\$1) with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:49 IBM_TDB			
68	BRS	0	(sum\$3 or total\$3 or accumulat\$3 or cumulat\$3) adj consumption\$1 adj time with (period\$1 or interval\$1) with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:50 IBM_TDB			

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
69	BRS	0	(sum\$3 or total\$3 or accumulat\$3 or cumulat\$3) adj consumption\$1 adj (period\$1 or interval\$1) with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:51 IBM_TDB			
70	BRS	3	(sum\$3 or total\$3 or accumulat\$3 or cumulat\$3) adj consumption\$1 adj (time or period\$1 or interval\$1) with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:52 IBM_TDB			
71	BRS	3	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3) adj consumption\$1 adj (time or period\$1 or interval\$1) with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:52 IBM_TDB			
72	BRS	16	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3) with consumption\$1 with time with (period\$1 or interval\$1) with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:56 IBM_TDB			

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
			(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3) with consumption\$1 with (power or resource\$1) with time with (period\$1 or interval\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:56 IBM_TDB			
	73 BRS	94	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3) with consumption\$1 with (power or resource\$1) with (successive or continuous) with time with (period\$1 or interval\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:57 IBM_TDB			
	74 BRS	1	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3) with consumption\$1 with (power or resource\$1) with (successive or continuous) with time with (period\$1 or interval\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:58 IBM_TDB			
	75 BRS	11	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3) with consumption\$1 with (power or resource\$1) with (successive or continuous) with (time or period\$1 or interval\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 09:58 IBM_TDB			

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
76	BRS	23	(sum\$4 or total\$3 or accumulat\$3 or cumulatt\$3 or add\$5) with consumption\$1 with (power or resource\$1) with (successive or continuous) with (time\$1 or period\$1 or interval\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; IBM_TDB	09:58		



	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definit on
77	BRS	12	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3 or add\$5) with consumption\$1 with (power or resource\$1) with (successive or continuous) with (time\$1 or period\$1 or interval\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) not ((sum\$4 or total\$3 or accumulat\$3 or cumulat\$3) with consumption\$1 with (power or resource\$1) with (successive or continuous) with (time or period\$1 or interval\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1))	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; IBM_TDB	10:01		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
78	BRS	0	(sum\$4 or total\$3 or accumulat\$3 or cumulatt\$3 or add\$5) with consumption\$1 with (power or resource\$1) with (successive or continuous) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with process\$3 with tool\$1	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; IBM_TDB	10:03		
79	BRS	1	(sum\$4 or total\$3 or accumulat\$3 or cumulatt\$3 or add\$5) with consumption\$1 with (power or resource\$1) with (successive or continuous) with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) not ((sum\$4 or total\$3 or accumulatt\$3 or cumulat\$3) with consumption\$1 with (power or resource\$1) with (successive or continuous) with (time or period\$1 or interval\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1))	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; IBM_TDB	10:02		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
			(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3 or add\$5) with consumption\$1 with (power or resource\$1) with (successive or continuous) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with process\$3	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 10:03 IBM_TDB			
80	BRS	60	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3 or add\$3) with consumption\$1 with (power or resource\$1) with (successive or continuous) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with process\$3	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 10:03 IBM_TDB			
81	BRS	55	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3 or add\$3) with consumption\$1 with (power or resource\$1) with (successive or continuous) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with process\$3	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 10:03 IBM_TDB			
82	BRS	0	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3 or add\$3) with (power or resource\$1) with (successive or continuous) with (time\$1 or interval\$1 or period\$1) with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with process\$3	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 10:04 IBM_TDB			

Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
83 BRS 0		(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3 or add\$3) with (power or resource\$1) with (successive or continuous) with (time\$1 or interval\$1 or period\$1) with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with process\$3 with tool\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 10:05		
84 BRS 1		(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3 or add\$3) with (power or resource\$1) with (successive or continuous) with (time\$1 or interval\$1 or period\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with process\$3 with tool\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 11:44		
85 BRS 2		"20020055801"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 10:56		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
86	IS&R	2	("5586059").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 14:37		
87	IS&R	2	("6368975").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 11:14		
88	BRS	2	(sum\$4 or total\$3 or accumulat\$3 or cumulat\$3 or add\$3) with (power or resource\$1) with (successive or continuous) with (time\$1 or duration\$1 or interval\$1 or period\$1) and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with process\$3 with tool\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 11:45		
89	BRS	9	(add\$3 or sum\$4 or accumulat\$3 or cumulat\$3 or total\$3) with consumption\$1 with (power or resource) with process\$3 with parameter\$1 and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 14:43		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
90	IS&R	2	("5586039").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 14:37		
91	BRS	0	report\$3 with consumption\$1 with (power or resource) with process\$3 with parameter\$1 and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with (gui or (graphical adj user adj interface))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 14:44		
92	BRS	0	(display\$3 or report\$3) with consumption\$1 with (power or resource) with process\$3 with parameter\$1 and (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with (gui or (graphical adj user adj interface))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 14:44		

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
93	BRS	0	(display\$3 or report\$3) with (power or resource) with process\$3 with parameter\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) with (gui or (graphical adj user adj interface))	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 14:45 IBM_TDB			
94	BRS	0	(display\$3 or report\$3) with (power or resource) with process\$3 with parameter\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) and (gui or (graphical adj user adj interface))	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 14:45 IBM_TDB			
95	BRS	0	(display\$3 or report\$3 or output) with (power or resource) with process\$3 with tool\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1) and (gui or (graphical adj user adj interface))	USPAT; US-PGPUB; EPO; 2004/09/02 JPO; DERWENT; 14:46 IBM_TDB			

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definiti on
96	BRS	12	(display\$3 or report\$3 or output) with (power or resource) with process\$3 with tool\$1 with (wafer\$1 or IC\$1 or integrated adj circuit\$1 or semiconductor\$1 or chip\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/02 14:46		